

Dual N-channel MOSFET

KFC6B22500L Datasheet

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1. GENERAL DESCRIPTION

Gate resistor installed Dual N-channel MOSFET for lithium-ion secondary battery protection circuits.

2. FEATURES

- Source-source On-state Resistance: RSS(on) typ = $8.3 \text{ m}\Omega$ (VGS = 3.8 V)
- CSP (Chip Size Package)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1)

3. MARKING SYMBOL: 3S

4. PACKAGING

Embossed type (Thermo-compression sealing): 10,000 pcs / reel (standard)

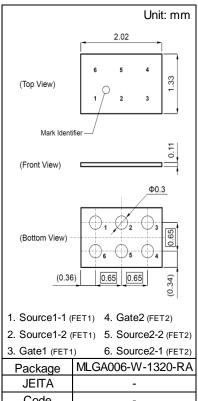
5. ABSOLUTE MAXIMUM RATINGS Ta = 25 °C

Parameter		Symbol	Rating	Unit	
Source-source Voltage		VSS	20	V	
Gate-source Voltage		VGS	± 12	V	
Source Current	DC *1	IS1	6.2		
	DC *2	IS2	11.5	А	
	DC *3	IS3	14.5		
	Pulsed *4	ISp	62		
	DC *1	PD1	0.44		
Total Power Dissipation	DC *2	PD2	1.5	W	
	DC *3	PD3	2.4		
Operating Junction and Storage Temperature Range		Tj, Tstg	- 55 to + 150	°C	

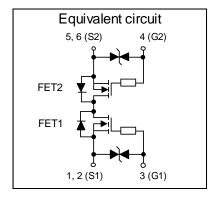
6. THERMAL CHARACTERISTICS Ta = 25 °C

Parameter	Symbol	Rating	Unit
	Rth1 *1	284	
Thermal Resistance (ch-a)	Rth2 *2	83	°C/W
	Rth3 *3	52	

- Note *1 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board partially covered with copper pad (30 mm² area, 36 µm thickness).
 - *2 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board fully covered with copper pad (610 mm² area, 36 µm thickness).
 - *3 Mounted on ceramic board (70 mm x 70 mm x t1.0 mm).
 - *4 $t = 10 \mu s$, Duty Cycle $\leq 1 \%$.



Code



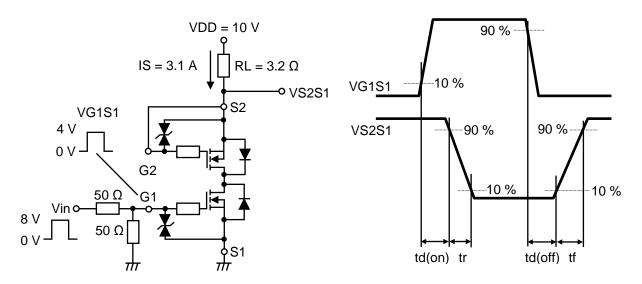


7. ELECTRICAL CHARACTERISTICS Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Source-source Breakdown Voltage	VSSS	IS = 1 mA, VGS = 0 V	20			V	
Zero Gate Voltage Source Current	ISSS	VSS = 20 V, VGS = 0 V			1	μΑ	
Cata aguiras Lagliaga Current	IGSS1	VGS = ± 8 V, VSS = 0 V			± 10		
Gate-source Leakage Current	IGSS2	VGS = ± 5 V, VSS = 0 V			± 1	μA	
Gate-source Threshold Voltage	Vth	IS = 0.57 mA, VSS = 10 V	0.35	0.90	1.40	V	
	RSS(on)1 IS = 3.1 A, VGS = 4.5 V 5.2	7.9	10.3				
	RSS(on)2	IS = 3.1 A, VGS = 3.8 V	5.5	8.3	10.8	0	
Source-source On-state Resistance	RSS(on)3	IS = 3.1 A, VGS = 3.1 V	5.8	9.2 14.7 mΩ			
	RSS(on)4	IS = 3.1 A, VGS = 2.5 V	6.3	11.1	21.8		
Body Diode Forward Voltage	VF(s-s)	IF = 3.1 A, VGS = 0 V		0.7	1.2	V	
Input Capacitance *1	Ciss			1600			
Output Capacitance *1	Coss	VSS = 10 V, VGS = 0 V, f = 1 kHz		165		pF	
Reverse Transfer Capacitance *1	Crss			130			
Turn-on Delay Time *1, *2	td(on)	VDD = 10 V, VGS = 0 to 4 V		0.4			
Rise Time *1, *2	tr	IS = 3.1 A		0.9		μs	
Turn-off Delay Time *1, *2	td(off)	VDD = 10 V, VGS = 4 to 0 V		2.1			
Fall Time *1, *2	tf	IS = 3.1 A		1.4		μs	
Total Gate Charge *1	Qg	VDD = 10 V		13			
Gate-source Charge *1	Qgs	VGS = 0 to 4 V		5.2		nC	
Gate-drain Charge *1	Qgd	IS = 6.2 A		4.0			

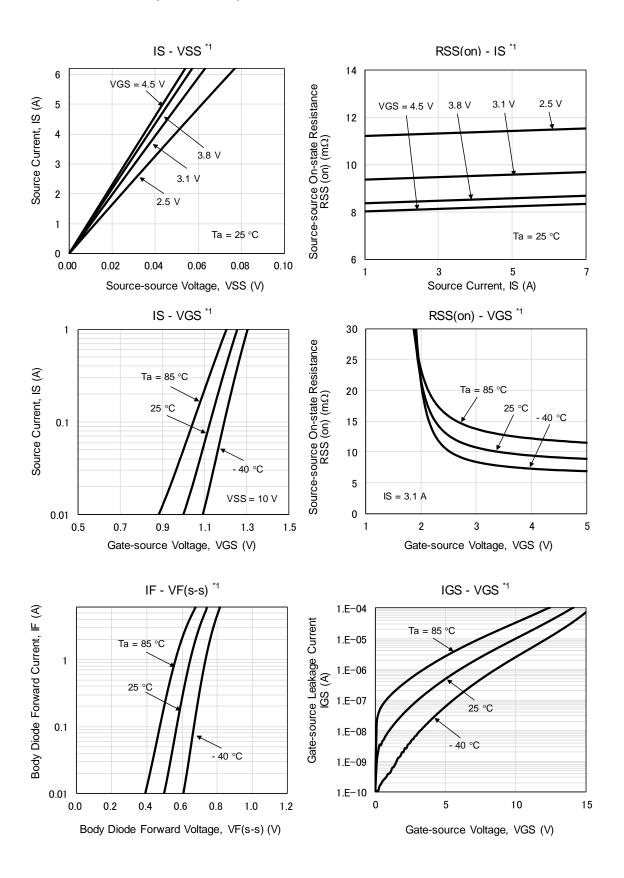
Note Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

- *1 Guaranteed by design, not subject to production testing.
- *2 Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time.



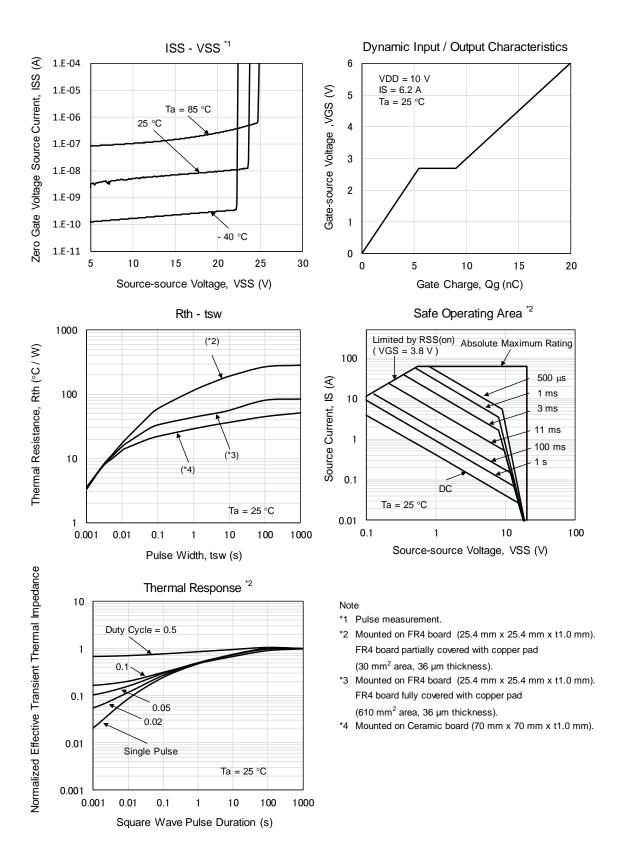


8. TECHNICAL DATA (Reference)





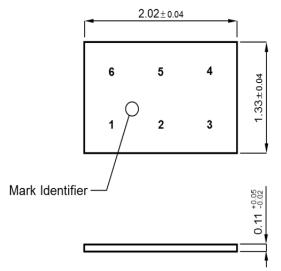
TECHNICAL DATA (Reference)





9. OUTLINE

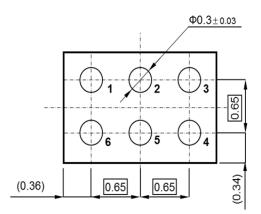
(Top View)



Unit: mm

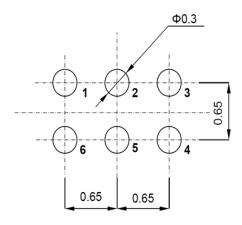
(Front View)

(Bottom View)



10. LAND & STENCIL PATTERN (Reference)

Unit: mm



Important notice:

Solder Mask Defined (SMD) pattern is strongly recommended for pad design.

Please check the information in the Nuvoton WL-CSP Application Notes about mounting process.



11. REVISION HISTORY

Date	Revision	Description
2021.10.28	1.00	1. Initially issued.



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